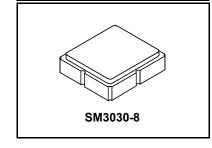


SF2159E

974 MHz **SAW Filter**



• SAW Filter for Digital Television

• Complies with Directive 2002/95/EC (RoHS)

Characteristics:

Balance-to-balanced Operation

Terminating Source/Load Impedance : Z_S = 150 Ω

Maximum Rating

Rating	Value	Units			
Input Power Level	0	dBm			
DC Voltage on any Non-ground Terminal	3	V			
Operating Temperature Range	-40 to +85	°C			
Storage Temperature Range in Tape and Reel	-40 to +85	°C			
Maximum Soldering Profile, 5 cycles/ 10 seconds maximum	265	°C			

Electrical Characteristics

Characteristic	Sym	Notes	Min	Тур	Max	Units
Center Frequency	f _C			974		MHz
Maximum Insertion Loss, 954 to 994 MHz	IL _{MAX}			3.1	4.5	dB
1.5 dB Passband				50		MHz
Amplitude Ripple, 954 to 994 MHz				1.0	2.5	dB _{P-P}
Attenuation, Referenced to IL _{MAX}						
50 to 891.94 MHz			45	51		
1056.06 to 1100 MHz			44	55		dB
2000 to 6000 MHz			15	20		
Group Delay Ripple, 954 to 994 MHz				23	35	ns _{P-P}

Case Style	SM3030-8 3.0 x 3.0 mm Nominal Footprint	
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	825, YWWS	
Standard Reel Quantity Reel Size 7 Inch	500 Pieces/Reel	
Reel Size 13 Inch	3000 Pieces/Reel	

Electrical Connections

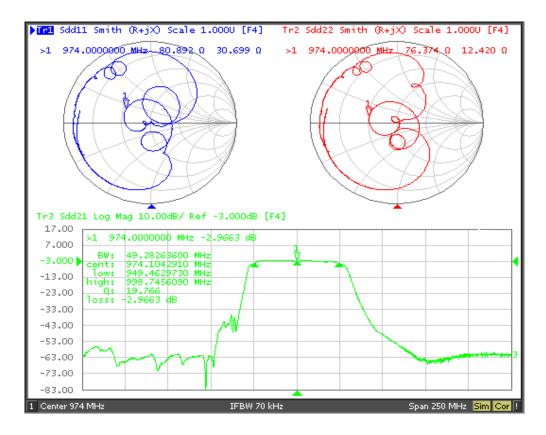
	Connection	Terminals		
Port 1	Balanced Input	1,2		
Port 2	Balanced Output	5,6		
	Ground	All Others		
Dot Indicates Pin 1				



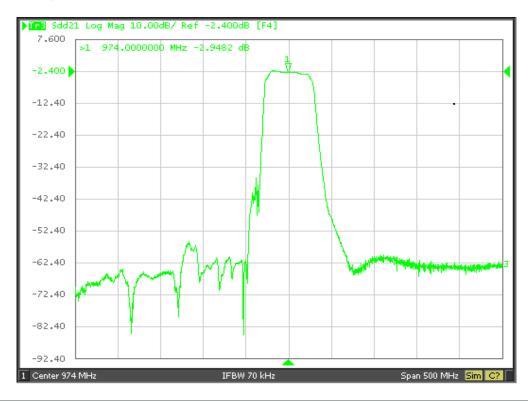
CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

- US and international patents may apply. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

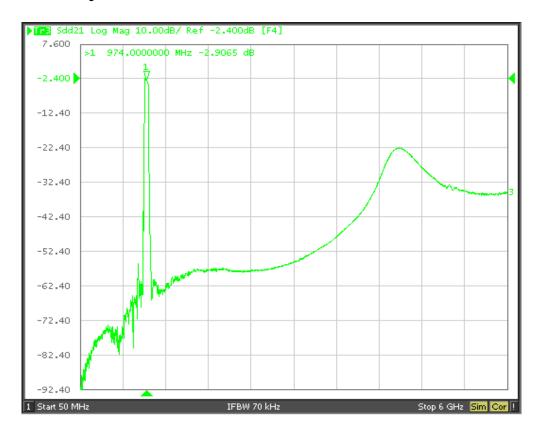
Filter S_{11} , S_{22} and S_{21} Plots



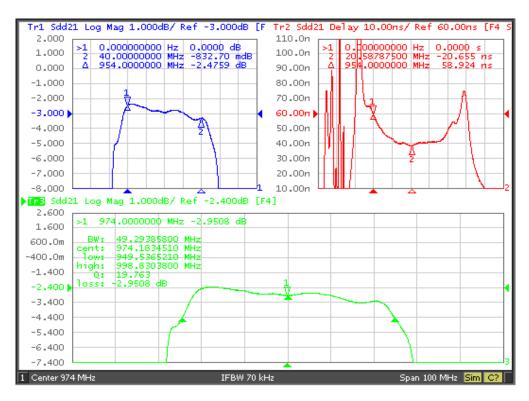
Filter Near-in Rejection



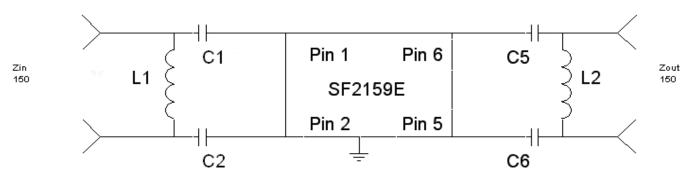
Filter Broadband Rejection



Filter Passband Amplitude and Group Delay Detail



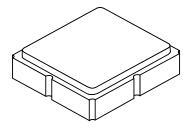
Tuning Network, 150 ohm Balanced Source/Load

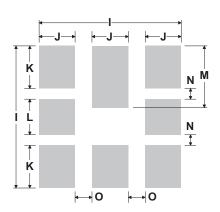


All other pins grounded

L1, L2 24 nH C1, C2, C3, C4 22 pF

8-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint





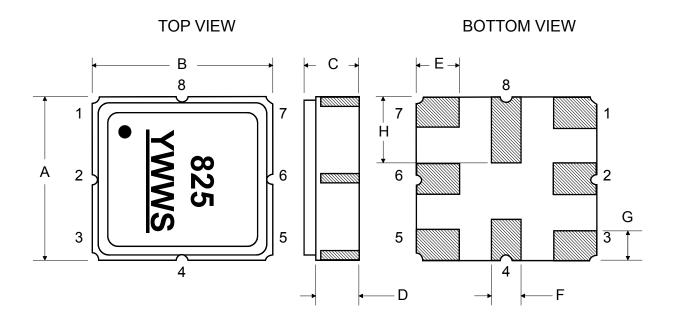
PCB Footprint Top View

Case and PCB Footprint Dimensions

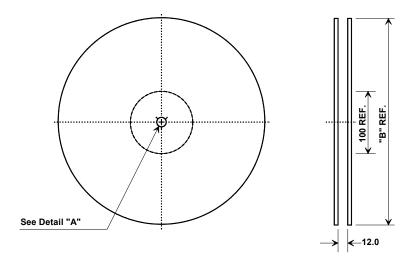
Dimension		mm			Inches	
Dimension	Min	Nom	Max	Min	Nom	Max
Α	2.87	3.0	3.13	0.113	0.118	0.123
В	2.87	3.0	3.13	0.113	0.118	0.123
С	1.14	1.27	1.40	0.045	0.050	0.055
D	0.79	0.92	1.05	0.031	0.036	0.041
E	0.62	0.75	0.88	0.024	0.029	0.034
F	0.47	0.60	0.73	0.018	0.024	0.029
G	0.47	0.60	0.73	0.018	0.024	0.029
Н	1.07	1.20	1.33	0.042	0.047	0.052
I		3.19			0.126	
J		0.81			0.032	
K		0.96			0.038	
L		0.81			0.032	
М		1.39			0.055	_
N		0.23			0.009	
0		0.38			0.015	

Case Materials

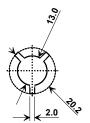
Materials			
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel		
Lid Plating	2.0 to 3.0 µm Nickel		
Body	Al ₂ O ₃ Ceramic		
Pb Free			



Tape and Reel Specifications



•	"B"	Quantity Per Reel
Inches	millimeters	Quality Fel Neel
7	178	1000
13	330	3000



Carrier Tape Dimensions				
Ao	3.35 mm			
Во	3.35 mm			
Ko	1.4 mm			
Pitch	8.0 mm			
W	12.0 mm			

COMPONENT ORIENTATION and DIMENSIONS

